ST1G3234

1-BIT DUAL SUPPLY BUS BUFFER LEVEL TRANSLATOR WITH A SIDE SERIES RESISTOR

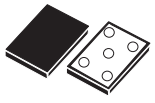
- HIGH SPEED: t_{PD} = 4.4ns (MAX.) at T_A=85°C
  V_{CCB} = 1.65V; V_{CCA} = 3.0V
- LOW POWER DISSIPATION:
  $I_{CCA} = I_{CCB}$ = 5µA(MAX.) at T_A=85°C
- SYMMETRICAL OUTPUT IMPEDANCE:
  $|I_{OHA}| = I_{OLA}$ = 10mA MIN at
  V_{CCA} = 2.75V; V_{CCB} = 1.4V to 3.6V
  $|I_{OHA}| = I_{OLA}$ = 6mA MIN at
  V_{CCA} = 2.3V; V_{CCB} = 1.4 to 3.6V)
- BALANCED PROPAGATION DELAYS:
  $t_{PLH} \cong t_{PHL}$
- POWER DOWN PROTECTION ON INPUTS AND OUTPUTS
- 26Ω SERIES RESISTOR ON A SIDE OUTPUTS
- OPERATING VOLTAGE RANGE:
  V_{CCA}(OPR) = 1.4V to 3.6V (1.2V Data Retent)
  V_{CCB}(OPR) = 1.4V to 3.6V (1.2V Data Retent)
- MAX DATA RATES:
  380 Mbps (1.8V to 3.3V translation)
  260 Mbps (<1.8V to 3.3V translation)
  260 Mbps (Translate to 2.5V)
  210 Mbps (Translate to 1.5V)
- LATCH-UP PERFORMANCE EXCEEDS 500mA (JESD 17)
- ESD PERFORMANCE:
  HBM > 2000V (MIL STD 883 method 3015);
  MM > 200V
- R_OHS Compliant for FLIPCHIP Package

DESCRIPTION

The ST1G3234 is a dual supply low voltage CMOS 1-BIT BUS BUFFER level translator fabricated with sub-micron silicon gate and five-layer metal wiring C^2MOS technology. Designed for use as an interface between a 3.3V bus and a 2.5V or 1.8V bus in a mixed 3.3V/1.8V, 3.3V/2.5V, 1.8V/1.4V and 2.5V/1.8V supply systems, it achieves high speed operation while maintaining the CMOS low power dissipation.

This IC is intended for one-way asynchronous communication between data buses. The input and output power down protections disable the device when both power supply are down, so that the buses are effectively isolated.

The input tolerant buffers allow to translate V_{CCB} compatible signals and greater signals than V_{CCB} up/down to V_{CCA}.



FLIP-CHIP

Table 1: Order Codes

PACKAGE	T & R	Comments
FLIP-CHIP5	ST1G3234BJR	4000 parts per reel

All inputs are equipped with protection circuits against static discharge, giving them ESD immunity and transient excess voltage.

Figure 1: Logic Diagram

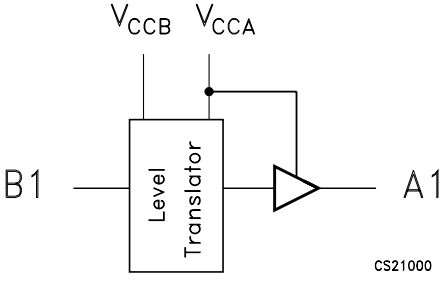


Figure 2: Input And Output Equivalent Circuit

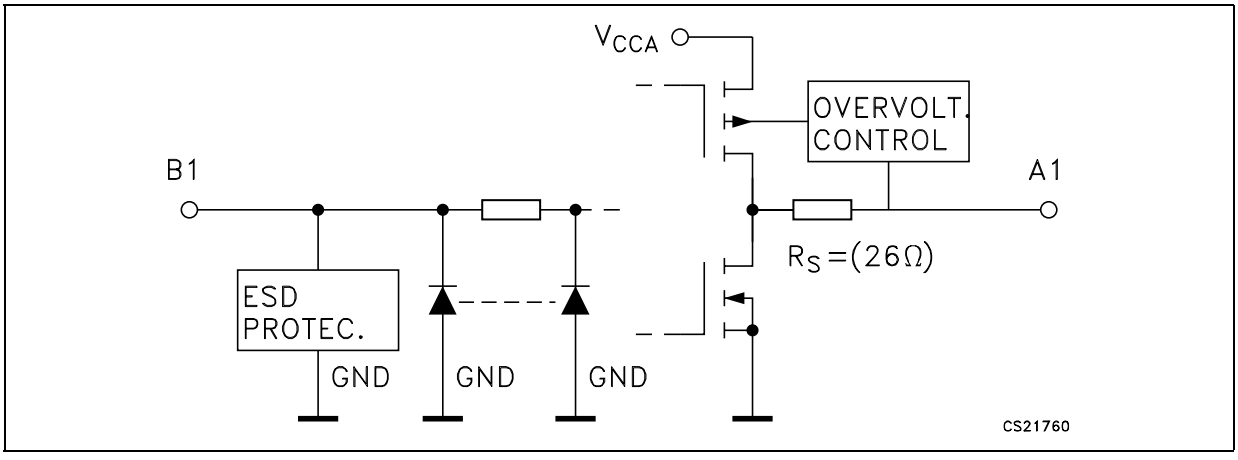


Table 2: Pin Description

PIN°	SYMBOL	NAME AND FUNCTION
A1	A1	Data Output (V_{CCA} referred)
C1	B1	Data Input (V_{CCB} referred)
B2	GND	Ground (0V)
A3	V_{CCA}	Positive Supply Voltage
C3	V_{CCB}	Positive Supply Voltage

Figure 3: Pin Connection (Top through view)

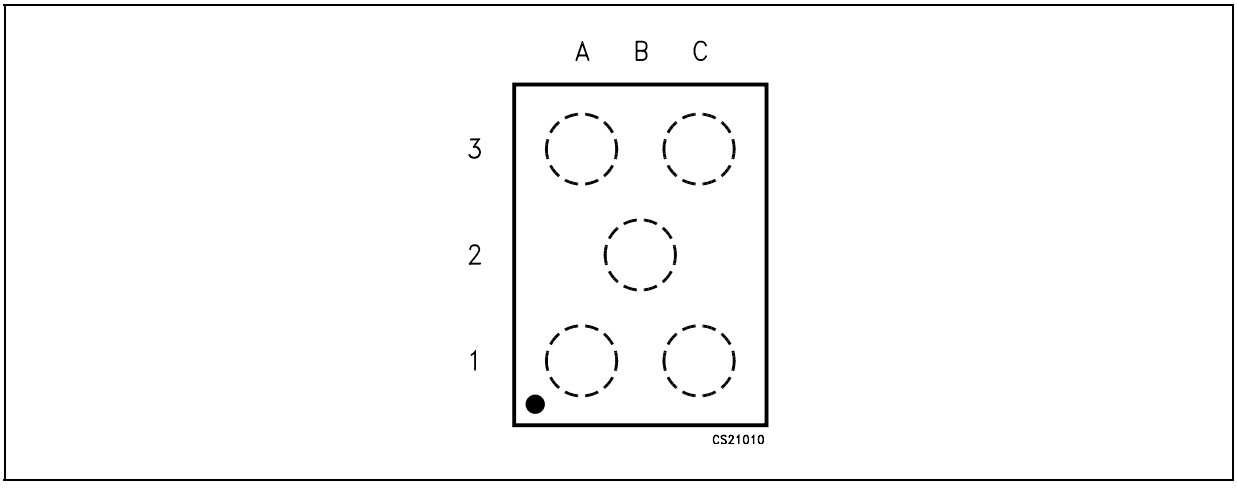


Table 3: Truth Table

INPUTS B1 (V_{CCB} Referred)	OUTPUTS A1 (V_{CCA} Referred)
L	L
H	H

Table 4: Absolute Maximum Ratings

Symbol	Parameter	Value	Unit
V_{CCA}	Output Supply Voltage	-0.5 to +4.6	V
V_{CCB}	Input Supply Voltage	-0.5 to +4.6	V
V_{OA}	DC Output Voltage (Power Down Mode: V_{CCA}=V_{CCB}=Gnd)	-0.5 to +4.6	V
V_{IB}	DC Input Voltage (Power Down Mode: V_{CCA}=V_{CCB}=Gnd)	-0.5 to +4.6	V
V_{OA}	DC Output Voltage	-0.5 to V_{CCA} + 0.5	V
V_{IB}	DC Input Voltage	-0.5 to +4.6	V
I_{IK}	DC Input Diode Current	– 20	mA
I_{OK}	DC Output Diode Current	– 50	mA
I_{OA}	DC Output Current	± 50	mA
I_{CCA}	DC V_{CCA} or Ground Current	± 100	mA
I_{CCB}	DC V_{CCB} or Ground Current	± 100	mA
P_d	Power Dissipation	200	mW
T_{stg}	Storage Temperature	-65 to +150	°C
T_L	Lead Temperature (10 sec)	260	°C

Absolute Maximum Ratings are those value beyond which damage to the device may occur. Functional operation under these conditions is not implied

Table 5: Recommended Operating Conditions

Symbol	Parameter		Value	Unit
V_{CCA}	Supply Voltage		1.4 to 3.6	V
V_{CCB}	Supply Voltage		1.4 to 3.6	V
V_{IB}	Input Voltage (B1)		0 to V_{CCB}	V
V_{OA}	Output Voltage (A1)		0 to V_{CCA}	V
T_{op}	Operating Temperature		-40 to 85	°C
dt/dv	Input Rise and Fall Time (note 1)	V_{CCB} = 3.0 to 3.6V	0 to 10	ns/V
		V_{CCB} = 2.3 to 2.7V	0 to 20	ns/V
		V_{CCB} = 1.4 to 1.95V	0 to 100	ns/V

1) V_I from 0.8V to 2.0V at V_{CC} = 3.0V

Table 6: DC Specification

Symbol	Parameter	Test Condition			Value					Unit
		V_{CCB} (V)(*)	V_{CCA} (V)(*)		T_A = 25 °C			-40 to 85 °C		
					Min.	Typ.	Max.	Min.	Max.	
V_{IHB}	High Level Input Voltage	1.4	1.4 to 3.6V		$0.65V_{CCB}$			$0.65V_{CCB}$		V
		1.8			$0.65V_{CCB}$			$0.65V_{CCB}$		
		2.5			1.6			1.6		
		3.3			2.0			2.0		
V_{ILB}	Low Level Input Voltage	1.4	1.4 to 3.6V				$0.35V_{CCB}$		$0.35V_{CCB}$	V
		1.8					$0.35V_{CCB}$		$0.35V_{CCB}$	
		2.5					0.7		0.7	
		3.3					0.8		0.8	
V_{OHA}	High Level Output Voltage	1.4 to 3.6V	1.4	I_O=-100µA	1.2			1.2		V
			2.75	I_O=-10mA	2.2			2.2		
			2.3	I_O=-8mA	1.8			1.8		
			1.65	I_O=-6mA	1.4			1.4		
			1.4	I_O=-2mA	1.1			1.1		
V_{OLA}	Low Level Output Voltage	1.4 to 3.6V	1.4	I_O=100µA			0.20		0.20	V
			2.75	I_O=1mA			0.40		0.40	
			2.75	I_O=10mA			0.55		0.55	
			2.3	I_O=6mA			0.40		0.40	
			1.65	I_O=2mA			0.25		0.25	
			1.4	I_O=1mA			0.20		0.20	
I_{IB}	Input Leakage Current	2.7	3.6	V_{IB} =V_{CCB} or GND			± 0.5		± 5	µA
		1.4	2.7	V_{IB} =3.6V or GND			± 0.5		± 5	µA
I_{OFF}	Power Off Leakage Current	0	0	V_{IB}=GND to 3.6V V_{OA}=GND to 3.6V			± 1.0		± 10	µA
I_{CCtB}	Quiescent Supply Current	1.4 to 3.6V	1.4 to 3.6V	V_{IB} =V_{CCB} or GND			0.5		5	µA
I_{CCtA}	Quiescent Supply Current	1.4 to 3.6V	1.4 to 3.6V	V_{IB} =V_{CCB} or GND			0.5		5	µA

(*) V_{CC} range = 3.3±0.3; 2.5±0.2V; 1.8±0.15V

Table 7: AC Electrical Characteristics

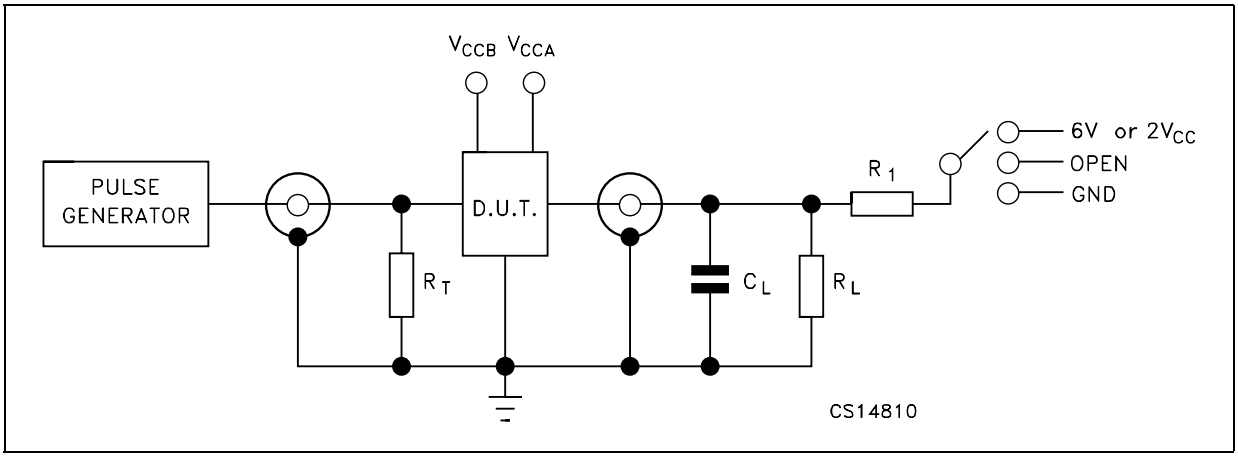
Symbol	Parameter	Test Condition			Value		Unit
		V_{CCB} (V)	V_{CCA} (V)		-40 to 85 °C		
					Min.	Max.	
t_{PLH} t_{PHL}	Propagation Delay Time B1 to A1	2.3 to 3.6	1.4	C_L = 10 pF	2.0	5.0	ns
		1.4 to 1.95	1.4		2.0	5.0	
		2.3 to 3.6	1.65 to 1.95		2.0	4.5	
		1.4 to 1.95	1.65 to 1.95		2.0	4.8	
		1.4 to 1.95	2.3 to 2.7		2.0	3.5	
		1.4 to 1.95	3.0 to 3.6		2.0	3.5	
		2.3 to 2.7	3.0 to 3.6		1.0	3.0	
t_{PLH} t_{PHL}	Propagation Delay Time B1 to A1	2.3 to 3.6	1.4	C_L = 30 pF R_L = 500 Ω	2.0	5.5	ns
		1.4 to 1.95	1.4		2.0	5.5	
		2.3 to 3.6	1.65 to 1.95		2.0	5.0	
		1.4 to 1.95	1.65 to 1.95		2.0	5.2	
		1.4 to 1.95	2.3 to 2.7		2.0	4.0	
		1.4 to 1.95	3.0 to 3.6		2.0	4.0	
		2.3 to 2.7	3.0 to 3.6		1.0	3.5	

Table 8: Capacitance Characteristics

Symbol	Parameter	Test Condition			Value					Unit
		V_{CCB} (V)	V_{CCA} (V)		T_A = 25 °C			-40 to 85 °C		
					Min.	Typ.	Max.	Min.	Max.	
C_{INB}	Input Capacitance	open	open			5				pF
C_O	Output Capacitance	2.5	3.3			6				pF
C_{PD}	Power Dissipation Capacitance	2.5	3.3	f=10MHz		27				pF
		1.8	3.3			27				
		1.4	2.5			23				
		1.4	1.8			20				
		3.3	1.8			27				

1) C_{PD} is defined as the value of the IC's internal equivalent capacitance which is calculated from the operating current consumption without load. (Refer to Test Circuit). Average current can be obtained by the following equation. $I_{CC(opr)} = C_{PD} \times V_{CC} \times f_{IN} + I_{CC}/4$ (per circuit)

Figure 4: Test Circuit



TEST	SWITCH
t_{PLH}, t_{PHL}	Open

C_L = 10/30pF or equivalent (includes jig and probe capacitance)
R_L = R_1 = 500Ω or equivalent
R_T = Z_{OUT} of pulse generator (typically 50Ω)

Table 9: Waveform Symbol Value

Symbol	V_{CC}		
	3.0 to 3.6V	2.3 to 2.7V	1.65 to 1.95V
V_{IH}	V_{CC}	V_{CC}	V_{CC}
V_M	1.5V	$V_{CC}/2$	$V_{CC}/2$
V_X	V_{OL} +0.3V	V_{OL} +0.15V	V_{OL} +0.15V
V_Y	V_{OL} -0.3V	V_{OL} -0.15V	V_{OL} -0.15V

Figure 5: Waveform - Propagation Delay (f=1MHz; 50% duty cycle)

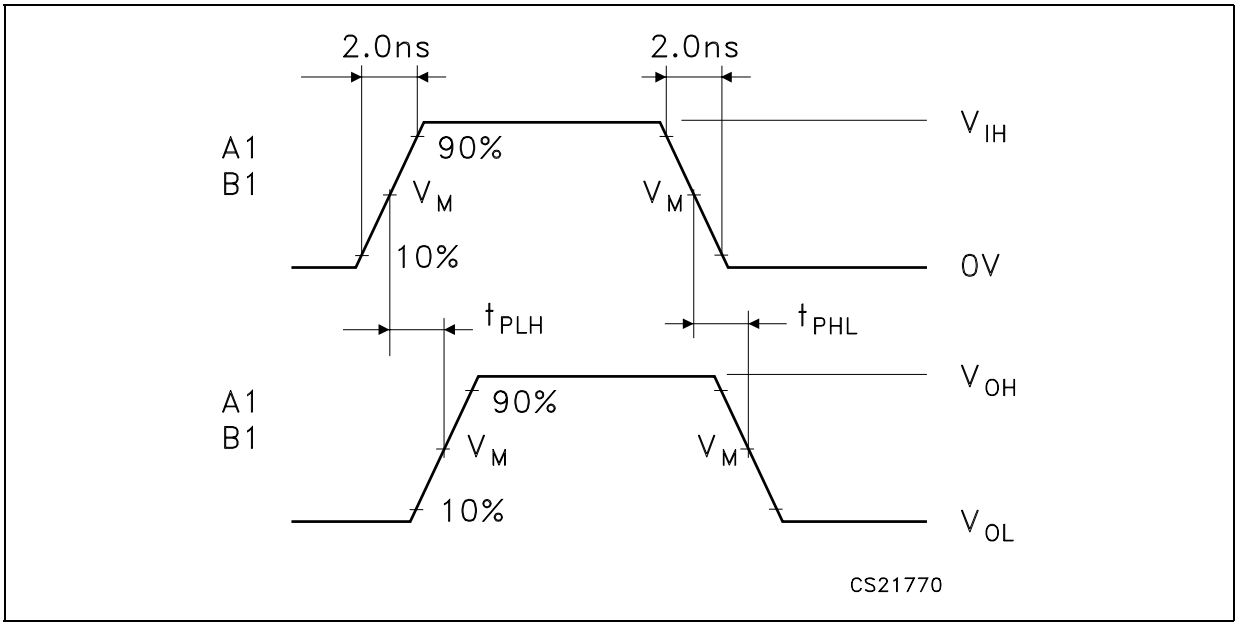
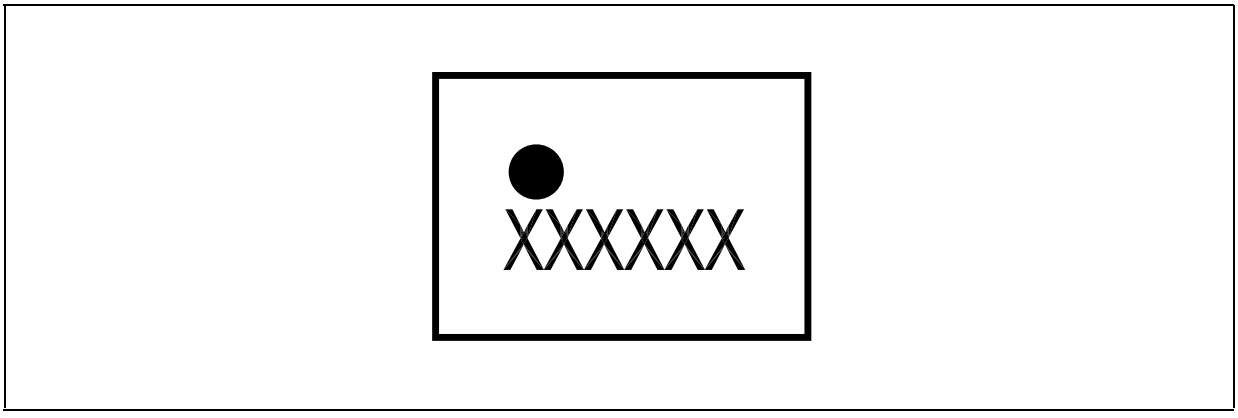


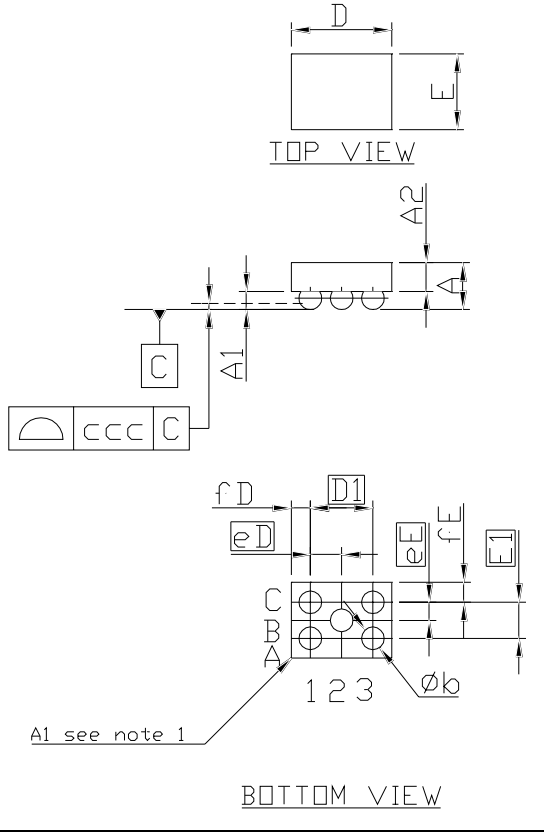
Figure 6: Marking



X = Marking Area; Marking Code 9537

Flip-Chip 5 MECHANICAL DATA

DIM.	mm.			mils		
	MIN.	TYP	MAX.	MIN.	TYP.	MAX.
A	0.585	0.65	0.715	23.0	25.6	28.1
A1	0.21	0.25	0.29	8.3	9.8	11.4
a2		0.40			15.7	
b	0.265	0.315	0.365	10.4	12.4	14.4
D	1.31	1.36	1.41	51.6	53.5	55.5
D1		0.866			34.1	
E	0.97	1.02	1.07	38.2	40.2	42.1
E1		0.5			19.7	
eD	0.383	0.433	0.483	15.1	17.0	19.0
eE	0.20	0.25	0.30	7.9	9.8	11.8
fD		0.247			9.7	
fE		0.260			10.2	
ccc		0.080			3.1	



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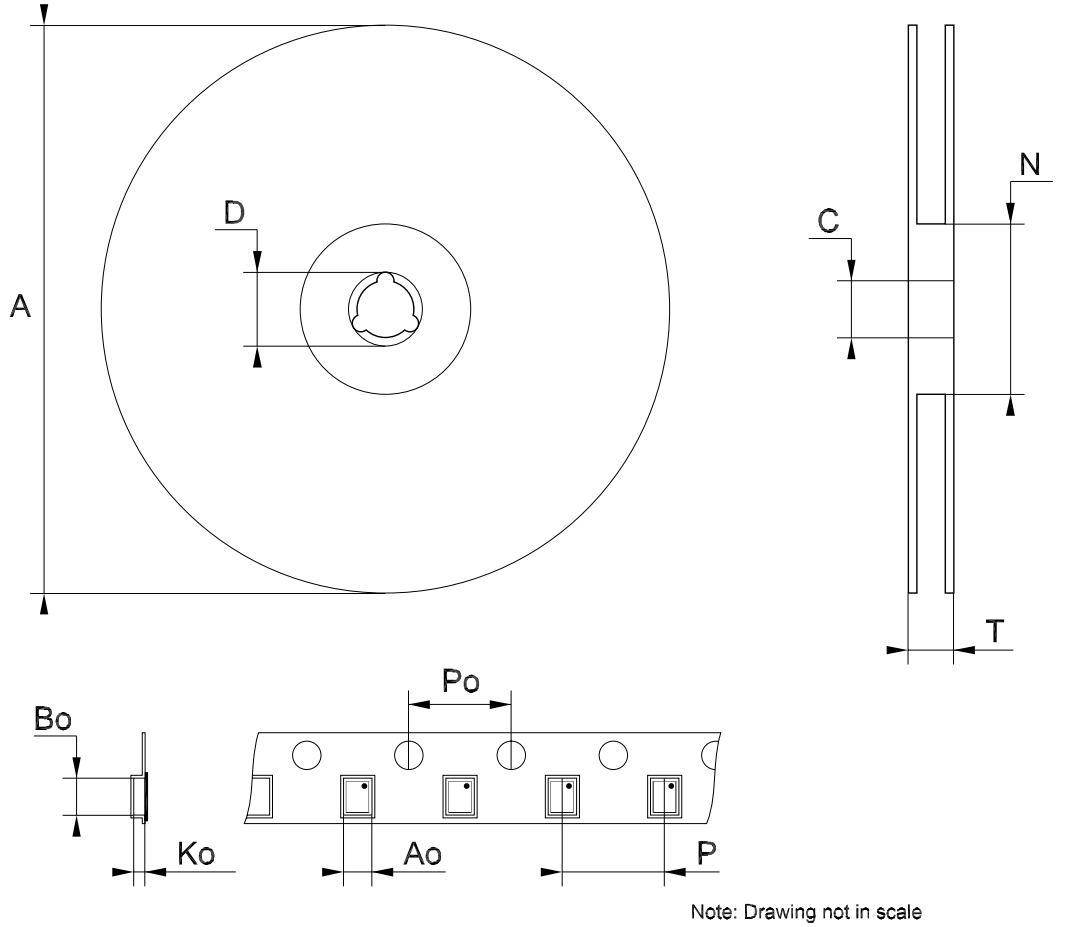
Tape & Reel Flip-Chip 5 MECHANICAL DATA

DIM.	mm.			inch		
	MIN.	TYP	MAX.	MIN.	TYP.	MAX.
A			178			6.926
C	12.8		13.2	0.504		0.519
D	20.2			0.795		
N	49	50	51	1.929	1.969	2.008
T			12.4			0.488
Ao	1.60	1.65	1.70	0.063	0.065	0.067
Bo	1.27	1.32	1.37	0.050	0.052	0.054
Ko	0.76	0.81	0.86	0.030	0.032	0.034
Po	3.9	4	4.1	0.153	0.157	0.161
P	3.9	4	4.1	0.153	0.157	0.161



Note: Drawing not in scale

Table 10: Revision History

Date	Revision	Description of Changes
14-Oct-2004	1	First Release.
20-Dec-2004	2	Revision on Table 3.
11-Feb-2005	3	Add Tape & Reel, Figures 2, 3, 5, 6, Tables 3, 5, 7 and Mechanical Data has been modified.
30-Mar-2005	4	Add Features ==> Max Data Rates.
09-May-2005	5	Table 7 and Table 8 have been updated..